

International **IR** Rectifier

Data Sheet No. PD60193

IR21093(S)

HALF-BRIDGE DRIVER

Features

- Floating channel designed for bootstrap operation
Fully operational to +600V
Tolerant to negative transient voltage
 dV/dt immune
- Gate drive supply range from 10 to 20V
- Undervoltage lockout for both channels
- 3.3V, 5V and 15V input logic compatible
- Cross-conduction prevention logic
- Matched propagation delay for both channels
- High side output in phase with IN input
- Logic and power ground +/- 5V offset
- Internal 540ns dead-time
- Lower di/dt gate driver for better noise immunity

Description

The IR21093(S) are high voltage, high speed power MOSFET and IGBT drivers with dependent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 600 volts.

Typical Connection

Product Summary

| | |
|----------------------------|-----------------|
| V _{OFFSET} | 600V max. |
| I _O +- | 120 mA / 250 mA |
| V _{OUT} | 10 - 20V |
| t _{on/off} (typ.) | 750 & 200 ns |
| Dead Time | 540 ns |

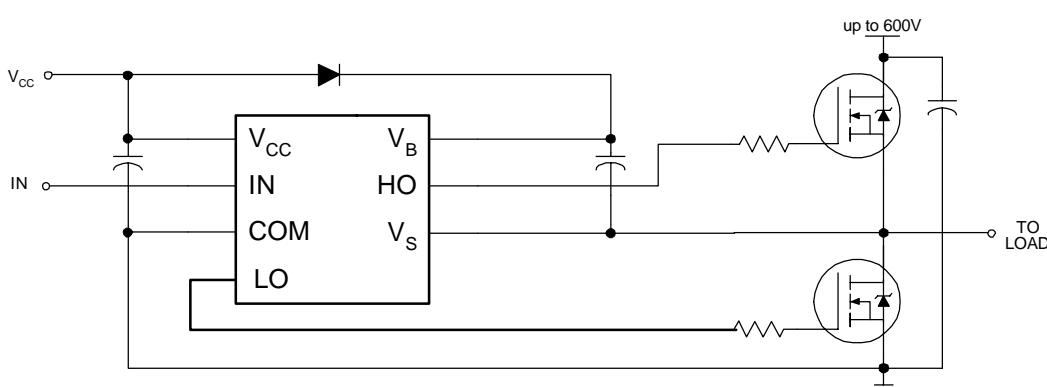
Packages



8-Lead PDIP



8-Lead SOIC



IR21093

(Refer to Lead Assignments for correct configuration). This/These diagram(s) show electrical connections only. Please refer to our Application Notes and DesignTips for proper circuit board layout.

Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

| Symbol | Definition | Min. | Max. | Units |
|------------|--|----------------|----------------|-------|
| V_B | High side floating absolute voltage | -0.3 | 625 | V |
| V_S | High side floating supply offset voltage | $V_B - 25$ | $V_B + 0.3$ | |
| V_{HO} | High side floating output voltage | $V_S - 0.3$ | $V_B + 0.3$ | |
| V_{CC} | Low side and logic fixed supply voltage | -0.3 | 25 | |
| V_{LO} | Low side output voltage | -0.3 | $V_{CC} + 0.3$ | |
| V_{IN} | Logic input voltage | $V_{SS} - 0.3$ | $V_{CC} + 0.3$ | |
| dV_S/dt | Allowable offset supply voltage transient | — | 50 | V/ns |
| P_D | Package power dissipation @ $T_A \leq +25^\circ\text{C}$ | — | 1.0 | W |
| | (8 Lead PDIP) | — | 0.625 | |
| R_{thJA} | Thermal resistance, junction to ambient | — | 125 | °C/W |
| | (8 Lead SOIC) | — | 200 | |
| T_J | Junction temperature | — | 150 | °C |
| T_S | Storage temperature | -50 | 150 | |
| T_L | Lead temperature (soldering, 10 seconds) | — | 300 | |

Recommended Operating Conditions

The input/output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions. The V_S offset rating is tested with all supplies biased at 15V differential.

| Symbol | Definition | Min. | Max. | Units |
|----------|--|------------|------------|-------|
| V_B | High side floating supply absolute voltage | $V_S + 10$ | $V_S + 20$ | V |
| V_S | High side floating supply offset voltage | Note 1 | 600 | |
| V_{HO} | High side floating output voltage | V_S | V_B | |
| V_{CC} | Low side and logic fixed supply voltage | 10 | 20 | |
| V_{LO} | Low side output voltage | 0 | V_{CC} | |
| V_{IN} | Logic input voltage | V_{SS} | V_{CC} | |
| T_A | Ambient temperature | -40 | 125 | °C |

Note 1: Logic operational for V_S of -5 to +600V. Logic state held for V_S of -5V to $-V_{BS}$. (Please refer to the Design Tip DT97-3 for more details).

Dynamic Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS}) = 15V, C_L = 1000 pF, and T_A = 25°C, unless otherwise specified.

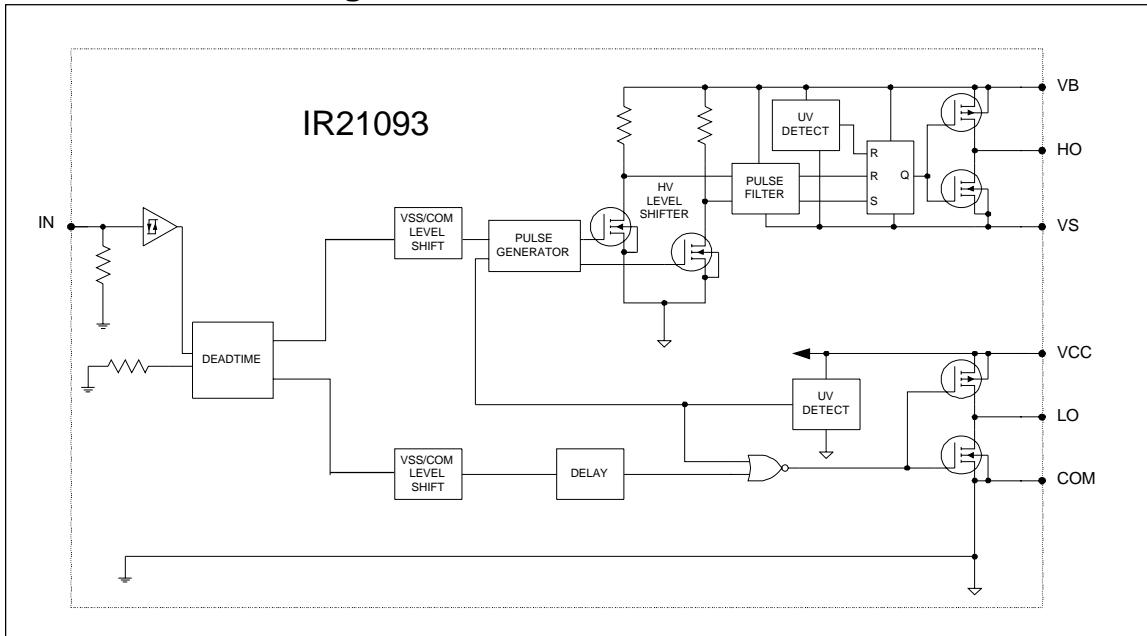
| Symbol | Definition | Min. | Typ. | Max. | Units | Test Conditions |
|-----------|---|------|------|------|-------|--------------------|
| t_{on} | Turn-on propagation delay | — | 750 | 950 | nsec | $V_S = 0V$ |
| t_{off} | Turn-off propagation delay | — | 200 | 280 | | $V_S = 0V$ or 600V |
| MT | Delay matching, HS & LS turn-on/off | — | 0 | 70 | | |
| t_r | Turn-on rise time | — | 150 | 220 | | $V_S = 0V$ |
| t_f | Turn-off fall time | — | 50 | 80 | | $V_S = 0V$ |
| DT | Deadtime: LO turn-off to HO turn-on(DTLO-HO) & HO turn-off to LO turn-on (DTHO-LO) | 400 | 540 | 680 | | |
| MDT | Deadtime matching = DTLO - HO - DTHO-LO | — | 0 | 60 | | |

Static Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS}) = 15V and T_A = 25°C unless otherwise specified. The V_{IL} , V_{IH} and I_{IN} parameters are referenced to COM and are applicable to the respective input leads. The V_O , I_O and R_{on} parameters are referenced to COM and are applicable to the respective output leads: HO and LO.

| Symbol | Definition | Min. | Typ. | Max. | Units | Test Conditions |
|----------------------------|--|------|------|------|---------|----------------------------------|
| V_{IH} | Logic "1" input voltage for HO & logic "0" for LO | 2.9 | — | — | V | $V_{CC} = 10V$ to 20V |
| V_{IL} | Logic "0" input voltage for HO & logic "1" for LO | — | — | 0.8 | | $V_{CC} = 10V$ to 20V |
| V_{OH} | High level output voltage, $V_{BIAS} - V_O$ | — | 0.8 | 1.4 | | $I_O = 20$ mA |
| V_{OL} | Low level output voltage, V_O | — | 0.3 | 0.6 | | $I_O = 20$ mA |
| I_{LK} | Offset supply leakage current | — | — | 50 | μA | $V_B = V_S = 600V$ |
| I_{QBS} | Quiescent V_{BS} supply current | 20 | 60 | 150 | | $V_{IN} = 0V$ or 5V |
| I_{QCC} | Quiescent V_{CC} supply current | 0.4 | 1.0 | 1.6 | mA | $V_{IN} = 0V$ or 5V $RDT = 0$ |
| I_{IN+} | Logic "1" input bias current | — | 5 | 20 | μA | $IN = 5V$, $SD = 0V$ |
| I_{IN-} | Logic "0" input bias current | — | 1 | 2 | | $IN = 0V$, $SD = 5V$ |
| V_{CCUV+} V_{BSUV+} | V_{CC} and V_{BS} supply undervoltage positive going threshold | 8.0 | 8.9 | 9.8 | V | |
| V_{CCUV-} V_{BSUV-} | V_{CC} and V_{BS} supply undervoltage negative going threshold | 7.4 | 8.2 | 9.0 | | |
| V_{CCUVH} V_{BSUVH} | Hysteresis | 0.3 | 0.7 | — | | |
| I_{O+} | Output high short circuit pulsed current | 120 | 200 | — | mA | $V_O = 0V$, $PW \leq 10 \mu s$ |
| I_{O-} | Output low short circuit pulsed current | 250 | 350 | — | | $V_O = 15V$, $PW \leq 10 \mu s$ |

Functional Block Diagrams



Lead Definitions

| Symbol | Description |
|-----------------|---|
| IN | Logic input for high and low side gate driver outputs (HO and LO), in phase with HO (referenced to COM) |
| V _B | High side floating supply |
| HO | High side gate drive output |
| V _S | High side floating supply return |
| V _{CC} | Low side and logic fixed supply |
| LO | Low side gate drive output |
| COM | Low side return |

Lead Assignments

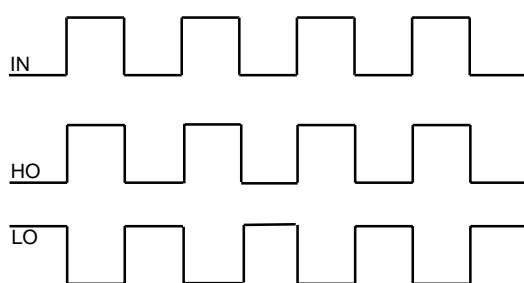
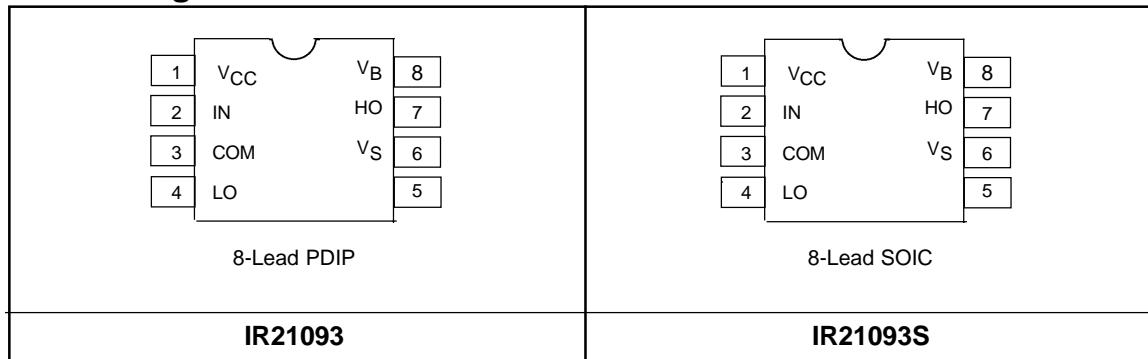


Figure 1. Input/Output Timing Diagram

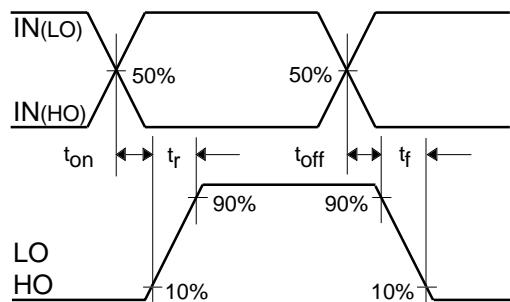


Figure 2. Switching Time Waveform Definitions

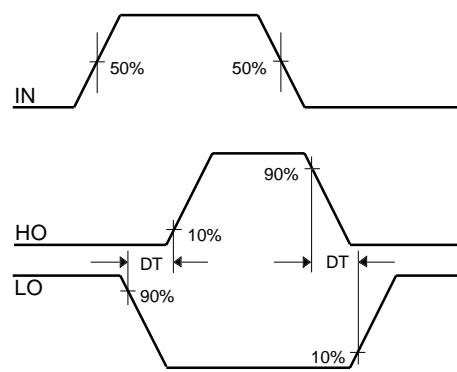


Figure 3. Deadtime Waveform Definitions

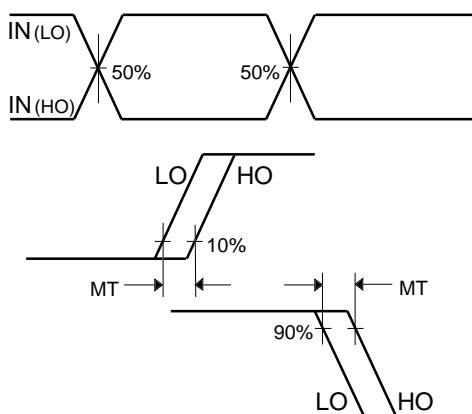


Figure 4. Delay Matching Waveform Definitions

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Case Outlines

